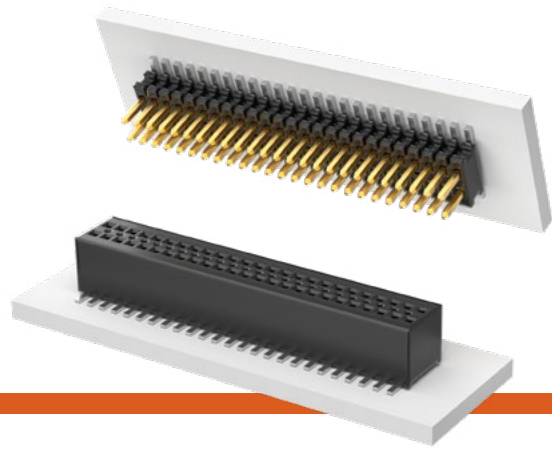


SMT MICRO HEADER & SOCKET

(0.80 mm) .0315" PITCH • FTE/CLE SERIES



FTE
Mates:
CLE

CLE
Mates:
FTE, AW

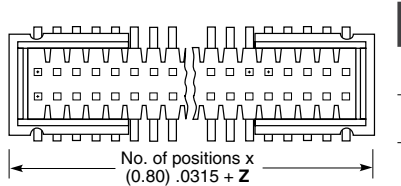
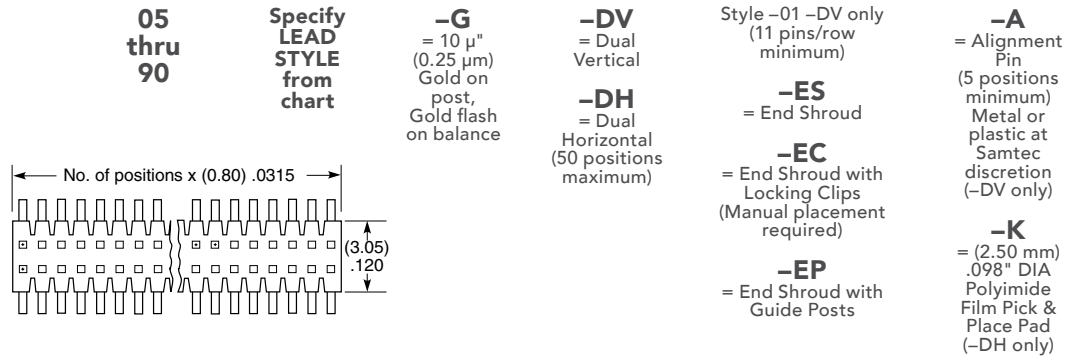
SPECIFICATIONS

Insulator Material:
Black Liquid Crystal Polymer
Terminal Material:
Phosphor Bronze
Contact Material:
BeCu
Plating:
Au over 50 μ" (1.27 μm) Ni
Current Rating (FTE/CLE):
2.7 A per pin
(2 pins powered)
Operating Temp Range:
-55 °C to +125 °C
Insertion Depth (CLE):
Top Entry =
(1.73 mm) .068" to (3.18 mm) .125"
with (0.38 mm) .015"
wipe, or pass-through
Bottom Entry =
(3.23 mm) .127" minimum plus
board thickness
Normal Force (CLE):
75 grams (0.73 N)
Max Cycles (CLE):
100 with 10 μ" (0.25 μm) Au

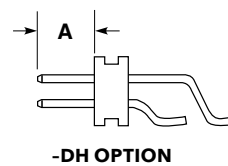
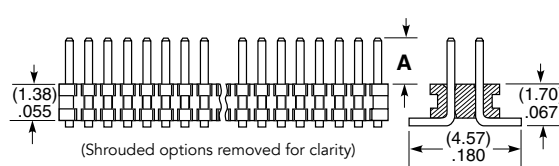
PROCESSING

Lead-Free Solderable:
Yes
SMT Lead Coplanarity (FTE):
-DV: (0.10 mm) .004" max
-DH: (0.10 mm) .004" max (05-25)
(0.15 mm) .006" max (26-50)*
*(.004" stencil solution
may be available; contact
IPG@samtec.com)
SMT Lead Coplanarity (CLE):
(0.10 mm) .004" max (04-65)
(0.15 mm) .006" max (66-90)*
*(.004" stencil solution
may be available; contact
ipg@samtec.com)

Note:
Some lengths, styles and
options are non-standard,
non-returnable.



OPTION	Z	LEAD STYLE	A
-ES	(1.57) .062	-01	(1.90) .075
-EC	(4.11) .162	-02	(4.45) .175
-EP	(5.51) .217	-03	(3.05) .120



04 thru 90

